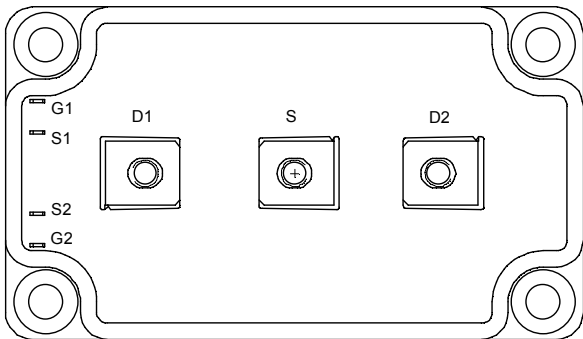
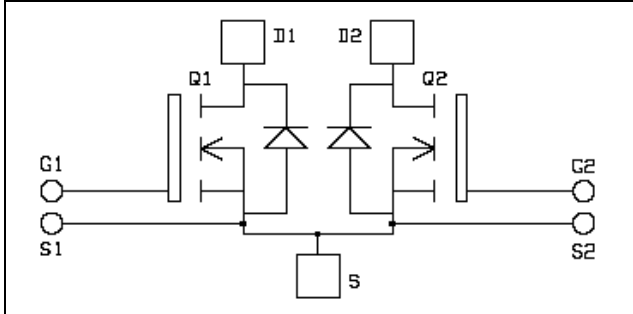


***Dual common source  
MOSFET Power Module***

**$V_{DSS} = 500V$   
 $R_{DSon} = 17m\Omega \text{ max @ } T_j = 25^\circ C$   
 $I_D = 180A \text{ @ } T_c = 25^\circ C$**



**Application**

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

**Features**

- Power MOS 7<sup>®</sup> MOSFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

**Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile

**Absolute maximum ratings**

<i>Symbol</i>	<i>Parameter</i>	<i>Max ratings</i>	<i>Unit</i>
$V_{DSS}$	Drain - Source Breakdown Voltage	500	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	180
		$T_c = 80^\circ C$	135
$I_{DM}$	Pulsed Drain current	720	A
$V_{GS}$	Gate - Source Voltage	$\pm 30$	V
$R_{DSon}$	Drain - Source ON Resistance	17	$m\Omega$
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	1250
$I_{AR}$	Avalanche current (repetitive and non repetitive)	51	A
$E_{AR}$	Repetitive Avalanche Energy	50	mJ
$E_{AS}$	Single Pulse Avalanche Energy	3000	

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$BV_{DSS}$	Drain - Source Breakdown Voltage	$V_{GS} = 0V, I_D = 500\mu A$	500			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 500V, T_j = 25^\circ\text{C}$			200	$\mu A$
		$V_{GS} = 0V, V_{DS} = 400V, T_j = 125^\circ\text{C}$			1000	
$R_{DS(on)}$	Drain - Source on Resistance	$V_{GS} = 10V, I_D = 90A$			17	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 10mA$	3		5	V
$I_{GSS}$	Gate - Source Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$			$\pm 200$	nA

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1MHz$		28		nF
$C_{oss}$	Output Capacitance			5.6		
$C_{rss}$	Reverse Transfer Capacitance			0.36		
$Q_g$	Total gate Charge	$V_{GS} = 10V$ $V_{Bus} = 250V$ $I_D = 180A$		560		nC
$Q_{gs}$	Gate - Source Charge			160		
$Q_{gd}$	Gate - Drain Charge			280		
$T_{d(on)}$	Turn-on Delay Time	<b>Inductive switching @ <math>125^\circ\text{C}</math></b> $V_{GS} = 15V$ $V_{Bus} = 333V$ $I_D = 180A$ $R_G = 0.5\Omega$		21		ns
$T_r$	Rise Time			38		
$T_{d(off)}$	Turn-off Delay Time			75		
$T_f$	Fall Time			93		
$E_{on}$	Turn-on Switching Energy ❶	<b>Inductive switching @ <math>25^\circ\text{C}</math></b> $V_{GS} = 15V, V_{Bus} = 333V$ $I_D = 180A, R_G = 0.5\Omega$		4140		$\mu J$
$E_{off}$	Turn-off Switching Energy ❷			3380		
$E_{on}$	Turn-on Switching Energy ❶	<b>Inductive switching @ <math>125^\circ\text{C}</math></b> $V_{GS} = 15V, V_{Bus} = 333V$ $I_D = 180A, R_G = 0.5\Omega$		6224		$\mu J$
$E_{off}$	Turn-off Switching Energy ❷			4052		

**Source - Drain diode ratings and characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_S$	Continuous Source current (Body diode)	$T_c = 25^\circ\text{C}$			180	A
		$T_c = 80^\circ\text{C}$			135	
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0V, I_S = -180A$			1.3	V
$dv/dt$	Peak Diode Recovery ❸				8	V/ns
$t_{rr}$	Reverse Recovery Time	$I_S = -180A, V_R = 250V$ $di_S/dt = 400A/\mu s$		680		ns
$Q_{rr}$	Reverse Recovery Charge	$I_S = -180A, V_R = 250V$ $di_S/dt = 400A/\mu s$		68		$\mu C$

❶  $E_{on}$  includes diode reverse recovery.

❷ In accordance with JEDEC standard JESD24-1.

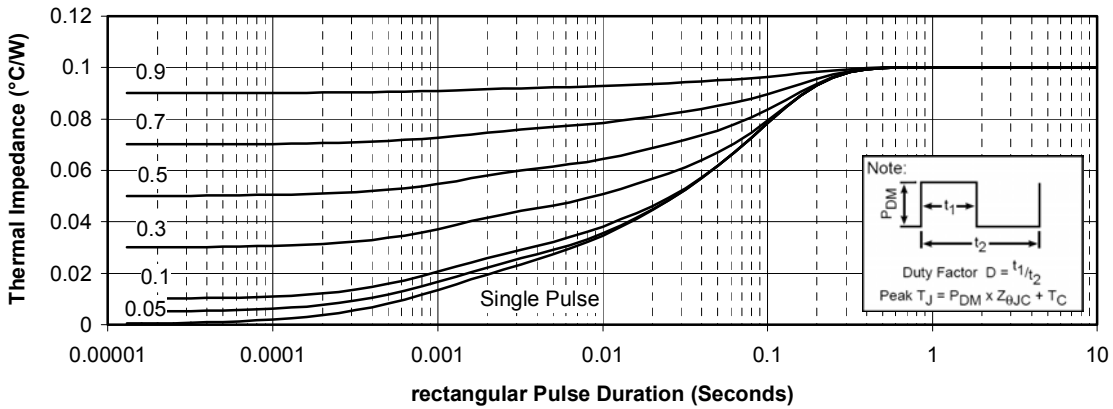
❸  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

$$I_S \leq -180A \quad di/dt \leq 700A/\mu s \quad V_R \leq V_{DSS} \quad T_j \leq 150^\circ\text{C}$$

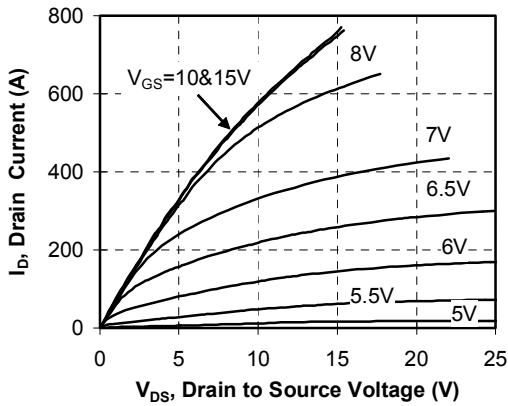


**Typical Performance Curve**

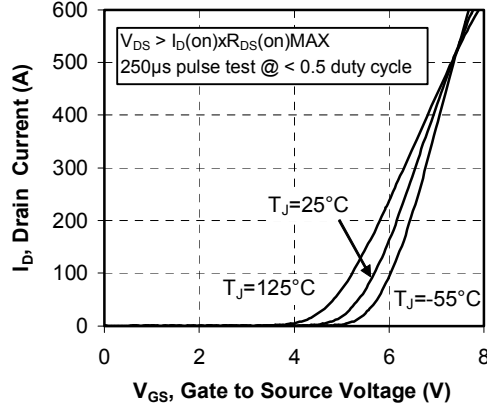
**Maximum Effective Transient Thermal Impedance, Junction to Case vs Pulse Duration**



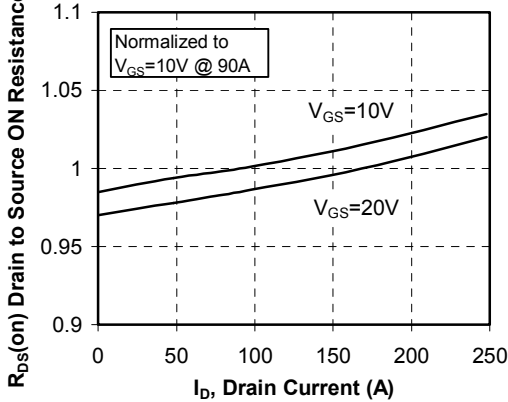
**Low Voltage Output Characteristics**



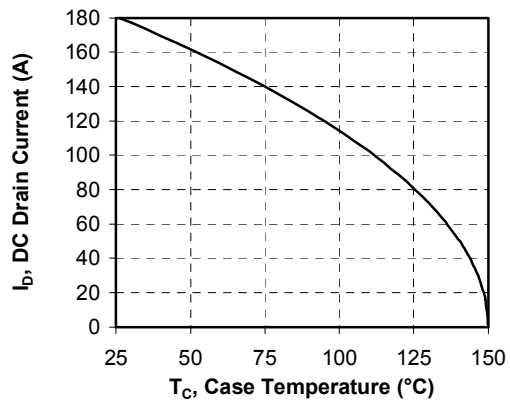
**Transfer Characteristics**

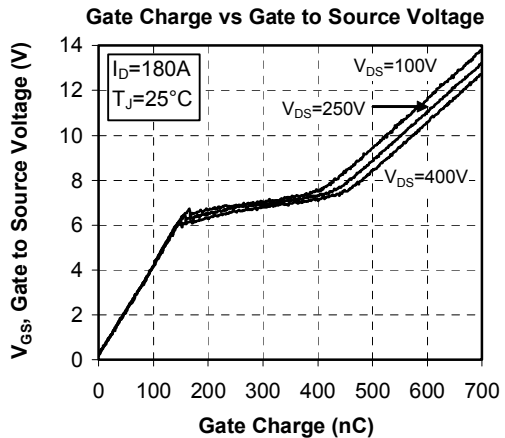
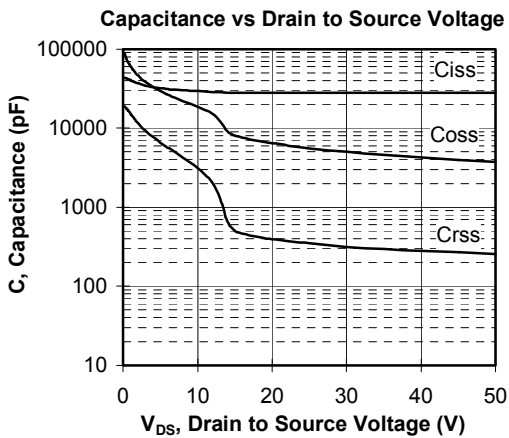
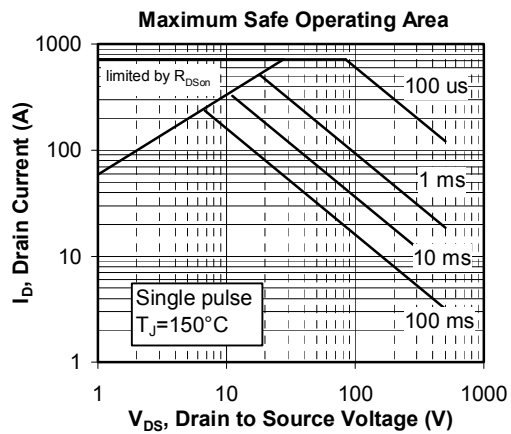
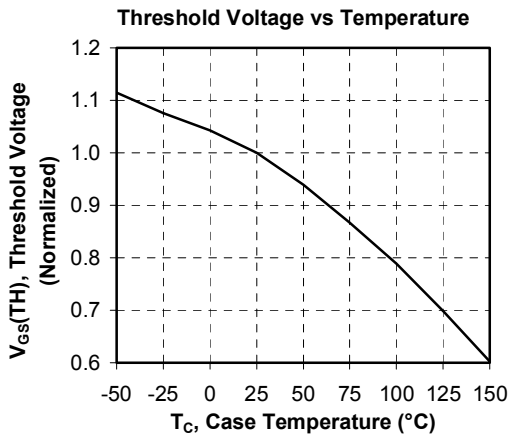
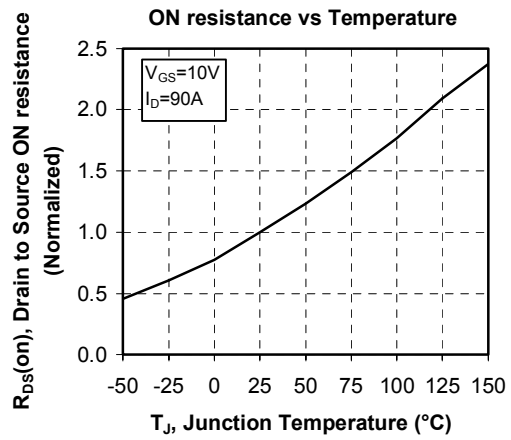
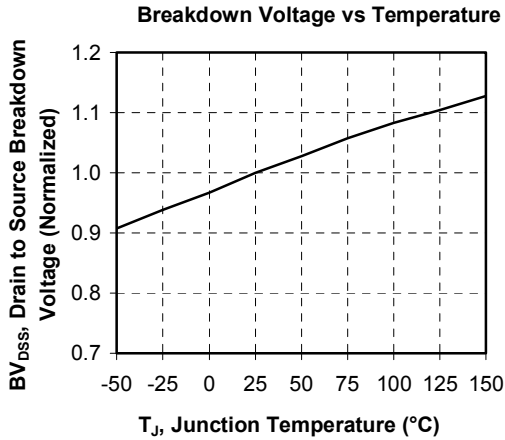


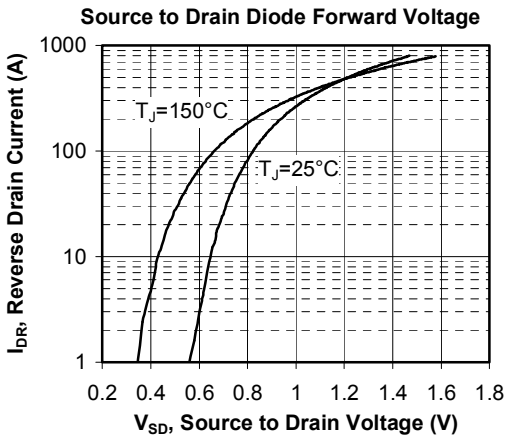
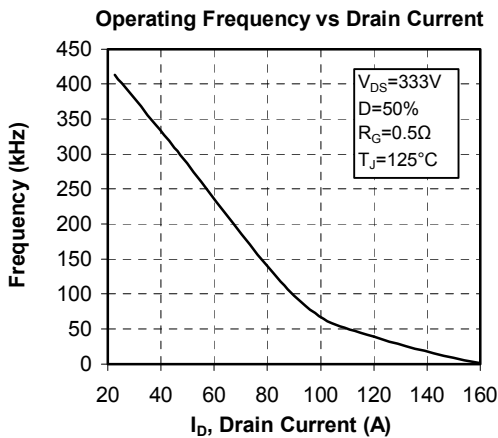
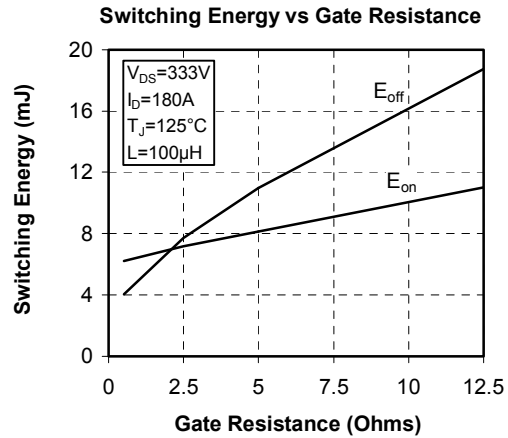
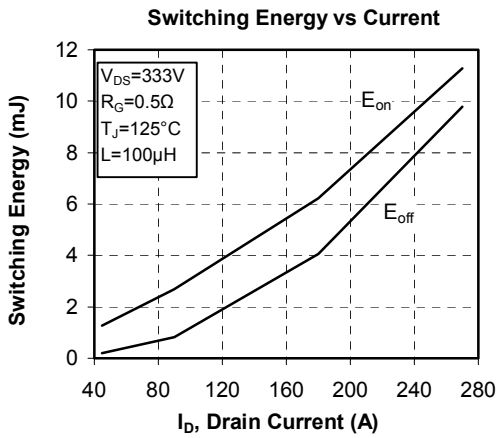
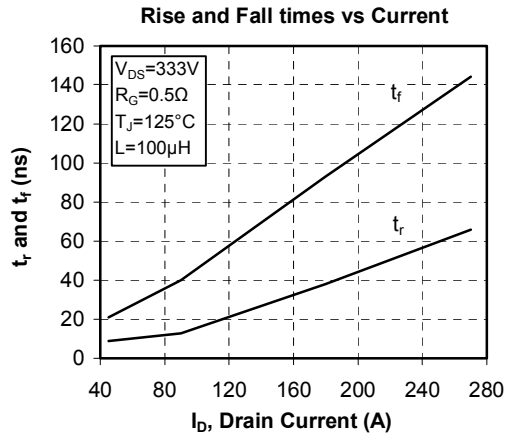
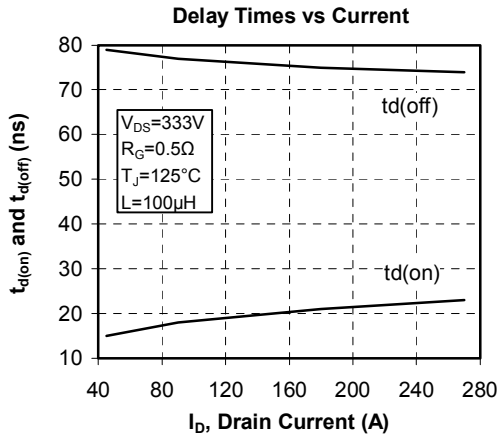
**R\_DS(on) vs Drain Current**



**DC Drain Current vs Case Temperature**







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